

1 Features and benefits

1.1 General features

- 5-port store and forward architecture
- Each port individually configurable for 10/100 Mbit/s when operated as MII/RMII and 10/100/1000 Mbit/s when operated as RGMII or SGMII
- Independent I/O voltage domains: selectable 1.8/2.5/3.3 V operation for MII/RMII/RGMII; selectable 1.8/2.5/3.3 V for host interfacing; 1.2 V core voltage domains
- Small footprint: LFBGA159 (12 mm × 12 mm) package
- Automotive Grade 2 ambient operating temperature: -40 °C to +105 °C
- Automotive product qualification in accordance with AEC-Q100 Rev-H

1.2 Ethernet switching and AVB features

- IEEE 802.3 compliant
- IEEE 802.1Q defined tag support
- 4096 VLANs supported
- Priority-based QoS handling as specified in IEEE 802.1Q
- Hardware support for IEEE 802.1AS timestamping and IEEE 802.1Qav AVB traffic shaping
- 16 credit-based shapers available according to IEEE 802.1Qav; shapers can be freely allocated to any priority queue on a per port basis
- Support for SR Class A, Class B, and Class C traffic
- IEEE 1588v2 one-step sync forwarding in hardware
- Statistics for dropped frames and buffer load

1.3 Interface features

- MII/RMII for interfacing with 10/100 Mbit/s PHYs/host processor (Fast Ethernet)
- RGMII for interfacing with 10/100/1000 Mbit/s PHYs/host processor/cascading (Gigabit Ethernet); internal delay for interface connection without external delay components
- SGMII for interfacing with 10/100/1000 Mbit/s PHYs/host processor/cascading
- MAC and PHY modes for interfacing (MII/RMII/RGMII/SGMII) directly with another switch or host processor
- Programmable drive strength for MII/RMII/RGMII interfaces
- SPI for host processor access

1.4 Other features

- 25 MHz system clock input from crystal oscillator or AC-coupled single-ended clock
- 25 MHz reference clock output
- Device reset input from host processor
- Synchronization output for cascading devices
- IEEE 1149.1/1149.6 compliant JTAG interface for TAP controller access and BSCAN

2 Related documentation

For the full data sheet and application hints, please register with DocStore at <https://www.docstore.nxp.com>.

3 Ordering information

Table 1. Ordering information

Type number	Package		
	Name	Description	Version
SJA1105PEL ^[1]	LFBGA159	plastic low profile fine-pitch ball grid array package; 159 balls	SOT1427-1
SJA1105QEL ^[1]			
SJA1105REL			
SJA1105SEL			

[1] Pin compatible with SJA1105 and SJA1105T.

NXP SJA1105 Ethernet Switch Series Selection Table

Features		SJA1105	SJA1105T	SJA1105P	SJA1105Q	SJA1105R	SJA1105S	Benefits
Package and Interfaces	Operating temperature range: -40°C to +105°C (Automotive Grade 2)	●	●	●	●	●	●	Flexible ECU design by: • support for any type of Ethernet PHY such as 100/1000BASE-T1 and 1000BASE-TX • up to four cascaded switches controlled by a single host
	LFPGA159 12x12mm2, 0,8mm pitch	●	●	●	●	●	●	
	MII (3V3)/RMII (3V3)/RGMII (3V3) interfaces	●	●					
	MII/RMII/RGMII (all 1V8, 2V5, 3V3) interfaces			●	●	●	●	
	RGMII internal delay line			●	●	●	●	
	SGMII interface					●	●	
	Pin compatibility	●	●	●	●	○	○	
Switching	Software compatibility	●	●	○	○	○	○	• Fine-grained control forwarding decisions in the network • Powerful debugging and diagnostic capabilities
	Hash-based L2 look-up table	●	●					
	TCAM-based frame filtering			●	●	●	●	
	Double VLAN tagging support			●	●	●	●	
	RMON RFC 2819 Ethernet counters			●	●	●	●	
	VLAN-based egress tagging/un-tagging	●	●	●	●	●	●	
	Frame mirroring and diagnostic features	●	●	●	●	●	●	
AVB/TSN	Credit-based shaping blocks for IEEE802.1Qav	10	10	16	16	16	16	Key hardware features to enable the implementation of a fully synchronized network for: • lip-synched playback of audio and video streams • data-transmission scheduling for TSN networks
	IEEE802.1AS time stamping support	●	●	●	●	●	●	
	TSN IEEE802.1Qbv: time-aware shaping		●		●		●	
	TSN IEEE802.1Qci* (pre-standard): per-stream policing		●		●		●	
Security	Ingress rate limiting on a per-port and per-priority basis for unicast/multicast and broadcast traffic	●	●	●	●	●	●	Provisions for: • authentication of the nodes connected to the network • limit the data generated by one or more connected devices.
	Port reachability limitation and disabling address learning setting	●	●	●	●	●	●	
	MAC address white & black Listing			●	●	●	●	
	Support for IEEE 802.1X-based authentication mechanism	●	●	●	●	●	●	
	Learn process with "one-shot" option			●	●	●	●	

4 Legal information

4.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

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